

## MSP430F2616 Device Erratasheet

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### 1 Functional Errata Revision History

Errata impacting device's operation, function or parametrics.

✓ The check mark indicates that the issue is present in the specified revision.

Errata Number	Rev H	Rev F	Rev E
ADC25	✓	✓	✓
BCL12	✓	✓	✓
BCL13			✓
BCL15	✓	✓	✓
DAC4	✓	✓	✓
DMA3	✓	✓	✓
DMA4	✓	✓	✓
DMA13	✓	✓	✓
FLASH19	✓	✓	✓
FLASH24	✓	✓	✓
FLASH25			✓
FLASH27	✓	✓	✓
FLASH36	✓	✓	✓
PORT10	✓	✓	✓
PORT12	✓	✓	✓
TA12	✓	✓	✓
TA16	✓	✓	✓
TA21	✓	✓	✓
TAB22	✓	✓	✓
TB2	✓	✓	✓
TB16	✓	✓	✓
TB24	✓	✓	✓
USCI20	✓	✓	✓
USCI21	✓	✓	✓
USCI22	✓	✓	✓
USCI23	✓	✓	✓
USCI24	✓	✓	✓
USCI25	✓	✓	✓
USCI26	✓	✓	✓
USCI27	✓	✓	✓
USCI30	✓	✓	✓
USCI34	✓	✓	✓
USCI35	✓	✓	✓
USCI40	✓	✓	✓
XOSC5	✓	✓	✓

Errata Number	Rev H	Rev F	Rev E
<a href="#">XOSC8</a>		✓	✓

## 2 Preprogrammed Software Errata Revision History

Errata impacting pre-programmed software into the silicon by Texas Instruments.

✓ The check mark indicates that the issue is present in the specified revision.

The device doesn't have Software in ROM errata.

## 3 Debug only Errata Revision History

Errata only impacting debug operation.

✓ The check mark indicates that the issue is present in the specified revision.

Errata Number	Rev H	Rev F	Rev E
<a href="#">JTAG23</a>	✓	✓	✓

## 4 Fixed by Compiler Errata Revision History

Errata completely resolved by compiler workaround. Refer to specific erratum for IDE and compiler versions with workaround.

✓ The check mark indicates that the issue is present in the specified revision.

Errata Number	Rev H	Rev F	Rev E
<a href="#">CPU8</a>	✓	✓	✓
<a href="#">CPU16</a>	✓	✓	✓
<a href="#">CPU19</a>	✓	✓	✓

Refer to the following MSP430 compiler documentation for more details about the CPU bugs workarounds.

### TI MSP430 Compiler Tools (Code Composer Studio IDE)

- [MSP430 Optimizing C/C++ Compiler](#): Check the --silicon\_errata option
- [MSP430 Assembly Language Tools](#)

### MSP430 GNU Compiler (MSP430-GCC)

- [MSP430 GCC Options](#): Check -msilicon-errata= and -msilicon-errata-warn= options
- [MSP430 GCC User's Guide](#)

### IAR Embedded Workbench

- [IAR workarounds for msp430 hardware issues](#)

## 5 Package Markings

### ZQW113

#### BGA (ZQW), 113 Pin



# = Die revision  
 ○ = Pin 1 location  
 N = Lot trace code

### PN80

#### LQFP (PN), 80 Pin



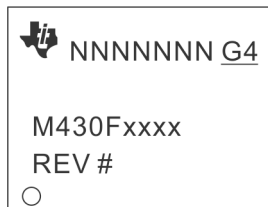
# = Die revision  
 ○ = Pin 1 location  
 N = Lot trace code



# = Die revision  
 ○ = Pin 1 location  
 N = Lot trace code

### PM64

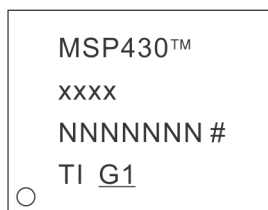
#### LQFP (PM), 64 Pin



# = Die revision  
 ○ = Pin 1 location  
 N = Lot trace code

### ZCA113

#### NFBGA (ZCA), 113 Pin



xxxx = Part number  
 N = Lot trace code  
 # = Die revision  
 ○ = Pin 1 location

## 6 Detailed Bug Description

### ADC25 *ADC12 Module*

**Category** Functional

**Function** Write to ADC12CTL0 triggers ADC12 when CONSEQ = 00

**Description** If ADC conversions are triggered by the Timer\_B module and the ADC12 is in single-channel single-conversion mode (CONSEQ = 00), ADC sampling is enabled by write access to any bit(s) in the ADC12CTL0 register. This is contrary to the expected behavior that only the ADC12 enable conversion bit (ADC12ENC) triggers a new ADC12 sample.

**Workaround** When operating the ADC12 in CONSEQ=00 and a Timer\_B output is selected as the sample and hold source, temporarily clear the ADC12ENC bit before writing to other bits in the ADC12CTL0 register. The following capture trigger can then be re-enabled by setting ADC12ENC = 1.

### BCL12 *BCS Module*

**Category** Functional

**Function** Switching RSELx or modifying DCOCTL can cause DCO dead time or a complete DCO stop

**Description** After switching RSELx bits (located in register BCCTL1) from a value of >13 to a value of <12 OR from a value of <12 to a value of >13, the resulting clock delivered by the DCO can stop before the new clock frequency is applied. This dead time is approximately 20 us. In some instances, the DCO may completely stop, requiring a power cycle.

Furthermore, if all of the RSELx bits in the BSCTL1 register are set, modifying the DCOCTL register to change the DCOx or the MODx bits could also result in DCO dead time or DCO hang up.

**Workaround** - When switching RSEL from >13 to <12, use an intermediate frequency step. The intermediate RSEL value should be 13.

Current RSEL	Target RSEL	Recommended Transition Sequence
15	14	Switch directly to target RSEL
14 or 15	13	Switch directly to target RSEL
14 or 15	0 to 12	Switch to 13 first, and then to target RSEL (two step sequence)
0 to 13	0 to 12	Switch directly to target RSEL

AND

- When switching RSEL from <12 to >13 it's recommended to set RSEL to its default value first (RSEL = 7) before switching to the desired target frequency.

AND

- In case RSEL is at 15 (highest setting) it's recommended to set RSEL to its default value first (RSEL = 7) before accessing DCOCTL to modify the DCOx and MODx bits. After the DCOCTL register modification the RSEL bits can be manipulated in an additional step.

In the majority of cases switching directly to intermediate RSEL steps as described above will prevent the occurrence of BCL12. However, a more reliable method can be

implemented by changing the RSEL bits step by step in order to guarantee safe function without any dead time of the DCO.

Note that the 3-step clock startup sequence consisting of clearing DCOCTL, loading the BCSCTL1 target value, and finally loading the DCOCTL target value as suggested in the in the "TLV Structure" chapter of the [MSP430x2xx Family User's Guide](#) is not affected by BCL12 if (and only if) it is executed after a device reset (PUC) prior to any other modifications being made to BCSCTL1 since in this case RSEL still is at its default value of 7. However any further changes to the DCOx and MODx bits will require the consideration of the workaround outlined above.

## **BCL13**

### ***BCS Module***

#### **Category**

Functional

#### **Function**

DCO powerup halt

#### **Description**

When subject to very slow Vcc rise times, the device may enter into a state where the DCO does not oscillate. No JTAG access or program execution is possible and the device will remain in a reset state until the supply voltage is disconnected.

#### **Workaround**

Apply a Vcc poweron ramp  $\geq 10\text{V/second}$  under all power-on/power-cycle scenarios.

## **BCL15**

### ***BCS Module***

#### **Category**

Functional

#### **Function**

Unpredictable device behavior if XT2 is sourcing SMCLK or MCLK while operating in LPM3

#### **Description**

If the MCLK or SMCLK is sourced by the XT2 oscillator, when the device wakes up from LPM3 or the SMCLK is requested by the USCI module an unpredictable glitch might appear. The glitch might appear on the corresponding clock signal with the 1st rising edge of the ACLK after wake-up. This can lead to a frequency violation.

In case of MCLK it can cause the device to hang up or execute code incorrectly.

In case of SMCLK any corresponding module using the clock can behave unpredictably.

#### **Workaround**

Do not use XT2 clock for MCLK/SMCLK when using LPM3

## **CPU8**

### ***CPUX Module***

#### **Category**

Compiler-Fixed

#### **Function**

Using odd values in the SP register

#### **Description**

If the stack pointer (SP) is written with an odd value then the first time that the SP is used, the LSB of the SP is forced to zero.

#### **Workaround**

Do not use odd values with the SP.

Refer to the table below for compiler-specific fix implementation information.

IDE/Compiler	Version Number	Notes
IAR Embedded Workbench	Not affected	
TI MSP430 Compiler Tools (Code Composer Studio)	Not affected	

IDE/Compiler	Version Number	Notes
MSP430 GNU Compiler (MSP430-GCC)	MSP430-GCC 4.9 build 389 or later	User is required to add the compiler flag option below. -msilicon-errata=cpu8 -msilicon-errata-warn=cpu8 generates a warning in addition
MSP430 GNU Compiler (MSP430-GCC)	MSP430-GCC 5.x build 14 or later	User is required to add the compiler flag option below. -msilicon-errata=cpu8 -msilicon-errata-warn=cpu8 generates a warning in addition

## CPU16

### *CPUX Module*

#### Category

Compiler-Fixed

#### Function

Indexed addressing with instructions calla, mova and bra.

#### Description

With indexed addressing mode and instructions calla, mova, and bra, it is not possible to reach memory above 64k if the register content is < 64k.

Example: Assume R5 = FFFEh. The instruction calla 0004h(R5) will result in a 20-bit call of address 0002h instead of 10002h.

#### Workaround

- Use different addressing mode to reach memory above 64k.

- First use adda [index],[Rx] to calculate address in upper memory and then do a calla [Rx]

Refer to the table below for compiler-specific fix implementation information.

IDE/Compiler	Version Number
IAR Embedded Workbench	IAR EW430 v6.30.1 or later
TI MSP430 Compiler Tools (Code Composer Studio)	Fix not available
MSP430 GNU Compiler (MSP430-GCC)	Fix not available

## CPU19

### *CPUX Module*

#### Category

Compiler-Fixed

#### Function

CPUOFF modification may result in unintentional register read

#### Description

If an instruction that modifies the CPUOFF bit in the Status Register is followed by an instruction with an indirect addressed operand (e.g. MOV @R8, R9, RET, POP, POPM), an unintentional register read operation can occur during the wakeup of the CPU. If the unintentional read occurs to a read sensitive register (e.g. UCB0RXBUF, TAIV), which changes its value or the value of other registers (IFG's), the bug leads to lost interrupts or wrong register read values.

#### Workaround

Insert a NOP instruction after each CPUOFF instruction.

OR

Refer to the table below for compiler-specific fix implementation information.

Note that compilers implementing the fix may lead to double stack usage when RET/RETA follows the compiler-inserted NOP.

IDE/Compiler	Version Number	Notes
IAR Embedded Workbench	IAR EW430 v6.20.1 until v6.40	User is required to add the compiler or assembler flag option below. --hw_workaround=nop_after_lpm
IAR Embedded Workbench	IAR EW430 v6.40 or later	Workaround is automatically enabled
TI MSP430 Compiler Tools (Code Composer Studio)	15.12.0.LTS	User is required to add the compiler or assembler flag option below. --silicon_errata=CPU19
MSP430 GNU Compiler (MSP430-GCC)	MSP430-GCC 4.9 build 389 or later	User is required to add the compiler or assembler flag option below. -msilicon-errata=cpu19 -msilicon-errata-warn=cpu19 generates a warning in addition
MSP430 GNU Compiler (MSP430-GCC)	MSP430-GCC 5.x build 14 or later	User is required to add the compiler or assembler flag option below. -msilicon-errata=cpu19 -msilicon-errata-warn=cpu19 generates a warning in addition

#### DAC4

#### *DAC12 Module*

**Category**

Functional

**Function**

DAC1 overwrites an input of the SVS comparator

**Description**

DAC1, when enabled (DAC12\_1CTL.DAC12AMPx >0), overrides the input of the SVS comparator if SVSCTL.VLDx = 1111 (comparing external input voltage SVSIN to 1.25 V.) This is caused by a conflict between SVS and DAC1 at Port 6.7. This behavior only affects DAC output pins shared with SVSIN function.

**Workaround**

- 1) Do not enable DAC1 when SVS is used with VLDx = 1111
- OR
- 2) Use DAC output pin not shared with SVSIN function

#### DMA3

#### *DMA Module*

**Category**

Functional

**Function**

Read-modify-write instructions may corrupt DMA address registers

**Description**

When a 16-bit wide read-modify-write instruction (such as add.w and sub.w) is directly used on a DMA address register (DMAxSA or DMAxDA), the register contents will get corrupted.

**Workaround**

1. Do not use 16-bit wide read-modify-write instructions on DMA address registers. Instead, in case address calculations are necessary, do the calculations first, and then assign the result to the DMA address registers.
- OR
2. Use 20-bit wide read-modify-write instructions (such as addx.a, subx.a) on the DMA address registers if needed.

<b>DMA4</b>	<b><i>DMA Module</i></b>
<b>Category</b>	Functional
<b>Function</b>	Corrupted write access to 20-bit DMA registers
<b>Description</b>	When a 20-bit wide write to a DMA address register (DMAxSA or DMAxDA) is interrupted by a DMA transfer, the register contents may be unpredictable.
<b>Workaround</b>	<ol style="list-style-type: none"> <li>1. Design the application to guarantee that no DMA access interrupts 20-bit wide accesses to the DMA address registers.</li> </ol> <p>OR</p> <ol style="list-style-type: none"> <li>2. When accessing the DMA address registers, enable the Read Modify Write disable bit (DMARMWDIS = 1) or temporarily disable all active DMA channels (DMAEN = 0).</li> </ol> <p>OR</p> <ol style="list-style-type: none"> <li>3. Use word access for accessing the DMA address registers. Note that this limits the values that can be written to the address registers to 16-bit values (lower 64K of Flash).</li> </ol>
<b>DMA13</b>	<b><i>DMA Module</i></b>
<b>Category</b>	Functional
<b>Function</b>	Clearing the DMAONFETCH bit may result in unpredictable code execution
<b>Description</b>	If the DMA module is used with DMACTL1.DMAONFETCH = 0, DMA transfer requests occur immediately upon receiving the request. This may result in unpredictable code execution by the CPU.
<b>Workaround</b>	Always ensure that DMACTL1.DMAONFETCH = 1. Note that this needs to be set explicitly by the user and is not the default setting for the DMACTL1 register.
<b>FLASH19</b>	<b><i>FLASH Module</i></b>
<b>Category</b>	Functional
<b>Function</b>	EEL feature does not work for code execution from RAM
<b>Description</b>	<p>When the program is executed from RAM, the flash controller EEL feature does not work. The erase cycle is suspended and the interrupt is serviced, but there is a problem while resuming with the erase cycle.</p> <p>Addresses applied to flash are different than the actual values while resuming erase cycle after ISR execution.</p>
<b>Workaround</b>	None
<b>FLASH24</b>	<b><i>FLASH Module</i></b>
<b>Category</b>	Functional
<b>Function</b>	Write or erase emergency exit can cause failures
<b>Description</b>	When a flash write or erase is abruptly terminated, the following flash accesses by the CPU may be unreliable resulting in erroneous code execution. The abrupt termination can be the result of one the following events:



- 1) The flash controller clock is configured to be sourced by an external crystal. An oscillator fault occurs thus stopping this clock abruptly.
- or
- 2) The Emergency Exit bit (EMEX in FCTL3) when set forces a write or an erase operation to be terminated before normal completion.
- or
- 3) The Enable Emergency Interrupt Exit bit (EEIEX in FCTL1) when set with GIE=1 can lead to an interrupt causing an emergency exit during a Flash operation.

**Workaround**

- 1) Use the internal DCO as the flash controller clock provided from MCLK or SMCLK.
- or
- 2) After setting EMEX = 1, wait for a sufficient amount of time before Flash is accessed again.
- or
- 3) No Workaround. Do not use EEIEX bit.

**FLASH25**
***FLASH Module***


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**Category**

Functional

**Function**

Marginal Read Mode is not functional

**Description**

The control bits for marginal read mode contained in the FCTL4 register are automatically cleared by any flash access. This prevents the marginal read mode from being used.

**Workaround**

It is possible to read out memory contents in marginal read mode if the indexed addressing mode X(Ry) is used to access the flash memory. In this case, the FCTL4 control bits are not cleared, and the marginal read mode works as expected. It is recommended to write the code for reading the flash memory contents in assembler as this allows full control over the used addressing mode. Note that certain assemblers may optimize an indexed addressing source operation of 0(Ry) to an indirect register mode @Ry operation, which will not work. The following is an example of reading the word memory location 0x4000 in marginal read mode, preventing a possible assembler optimization:

```
mov.w #0x4000,R15 ; Pointer to target address
```

```
dec.w R15 ; Decrement pointer
```

```
mov.w 1(R15),R12 ; Read memory contents at R15+1, store result in R12
```

**FLASH27**
***FLASH Module***


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**Category**

Functional

**Function**

EEL feature can disrupt segment erase

**Description**

When a flash segment erase operation is active with EEL feature selected (EEL=1 in FLCTL1) and GIE=0, the following can occur:

An interrupt event causes the flash erase to be stopped, and the flash controller expects an RETI to resume the erase. Because GIE=0, interrupts are not serviced and RETI will never happen.

**Workaround**

1) Do not set bit EEI=1 when GIE = 0.  
or,  
2) Force an RETI instruction during the erase operation during the check for BUSY=1 (FCTL3).  
Sample code:  
MOV R5, 0(R5) ; Dummy write, erase segment  
LOOP: BIT #BUSY, &FCTL3 ; test busy bit  
JMP SUB\_RETI ; Force RETI instruction  
JNZ LOOP ; loop while BUSY=1  
SUB\_RETI: PUSH SR  
RETI

### **FLASH36** *FLASH Module*

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**Category** Functional

**Function** Flash content may degrade due to aborted page erases

**Description** If a page erase is aborted by EEIEX, the flash page containing the last instruction before erase operation will start to degrade. This effect is incremental and, after repetitions, may lead to corrupted flash content.

**Workaround**

- Use the EEI (interrupted erasing) feature instead of EEIEX (abort erasing).  
or  
- A PSA checksum can be calculated over affected flash page using the marginal read mode (marginal 0). If PSA sum differs from expected PSA value the affected flash page has to be reprogrammed.  
or  
- Start flash erasing from RAM and limit system frequency to <1MHz (to ensure 6-us delay after EEIEX). If the last instruction before erasing is located in RAM, flash cell degradation does not occur.

### **JTAG23** *JTAG Module*

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**Category** Debug

**Function** PSA checksum calculation does not work in marginal read mode.

**Description** If the PSA checksum is calculated via JTAG interface in marginal read mode the MRG0 and MRG1 bits in the FCTL4 register are reset.

**Workaround** None.

### **PORT10** *PORT Module*

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**Category** Functional

**Function** Pull-up/down resistor selection when module pin function is selected

**Description** When the pull-up/down resistor for a certain port pin is enabled (PxREN.y=1) and the module port pin function is selected (PxSEL.y=1), the pull-up/down resistor configuration

of this pin is controlled by the respective module output signal (Module X OUT) instead of the port output register (PxOUT.y).

**Workaround** None. Do not set PxSEL.y and PxREN.y at the same time.

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## **PORT12** *PORT Module*

**Category** Functional

**Function** PxIFG is set on PUC

**Description** The PxIN register is cleared when a PUC is asserted, and it regains the original value after the PUC is de-asserted. If the PxIN register bits read high, asserting a PUC causes clearing of the register, which results in a high-to-low transition. Once the PUC is de-asserted, the PxIN register is restored to high, which results in a low-to-high transition. This behavior results in the PxIFG being set regardless of the PxIES setting.

**Workaround** Prior to setting PxIE bits ensure that corresponding PxIFG bits are cleared.

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## **TA12** *TIMER\_A Module*

**Category** Functional

**Function** Interrupt is lost (slow ACLK)

**Description** Timer\_A counter is running with slow clock (external TACLK or ACLK) compared to MCLK. The compare mode is selected for the capture/compare channel and the CCRx register is incremented by one with the occurring compare interrupt (if TAR = CCRx). Due to the fast MCLK the CCRx register increment (CCRx = CCRx+1) happens before the Timer\_A counter has incremented again. Therefore the next compare interrupt should happen at once with the next Timer\_A counter increment (if TAR = CCRx + 1). This interrupt gets lost.

**Workaround** Switch capture/compare mode to capture mode before the CCRx register increment. Switch back to compare mode afterwards.

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## **TA16** *TIMER\_A Module*

**Category** Functional

**Function** First increment of TAR erroneous when IDx > 00

**Description** The first increment of TAR after any timer clear event (POR/TACLK) happens immediately following the first positive edge of the selected clock source (INCLK, SMCLK, ACLK or TACLK). This is independent of the clock input divider settings (ID0, ID1). All following TAR increments are performed correctly with the selected IDx settings.

**Workaround** None

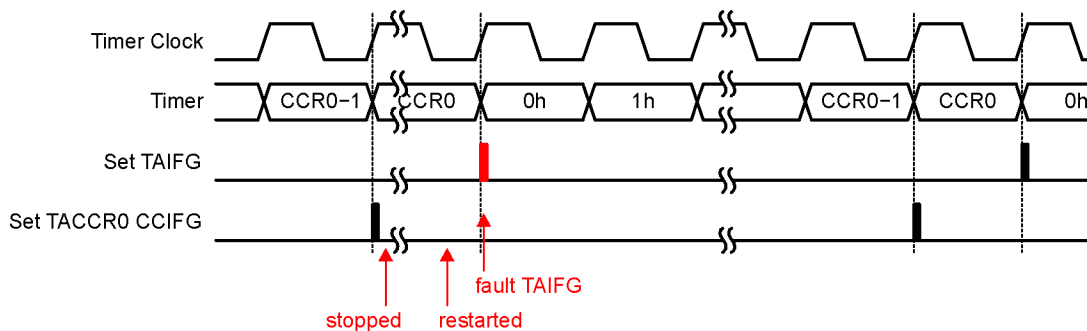
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## **TA21** *TIMER\_A Module*

**Category** Functional

**Function** TAIFG Flag is erroneously set after Timer A restarts in Up Mode

**Description** In Up Mode, the TAIFG flag should only be set when the timer counts from TACCR0 to zero. However, if the Timer A is stopped at TAR = TACCR0, then cleared (TAR=0) by setting the TACLRL bit, and finally restarted in Up Mode, the next rising edge of the TACLK will erroneously set the TAIFG flag.



**Workaround** None.

## TAB22 *TIMER\_A/TIMER\_B Module*

**Category** Functional

**Function** Timer\_A/Timer\_B register modification after Watchdog Timer PUC

**Description** Unwanted modification of the Timer\_A/Timer\_B registers TACTL/TBCTL and TAIV/TBIV can occur when a PUC is generated by the Watchdog Timer(WDT) in Watchdog mode and any Timer\_A/Timer\_B counter register TACCRx/TBCCRx is incremented/decremented (Timer\_A/Timer\_B does not need to be running).

**Workaround** Initialize TACTL/TBCTL register after the reset occurs using a MOV instruction (BIS/BIC may not fully initialize the register). TAIV/TBIV is automatically cleared following this initialization.

Example code:

```
MOV.W #VAL, &TACTL
```

or

```
MOV.W #VAL, &TBCTL
```

Where, VAL=0, if Timer is not used in application otherwise, user defined per desired function.

## TB2 *TIMER\_B Module*

**Category** Functional

**Function** Interrupt is lost (slow ACLK)

**Description** Timer\_B counter is running with slow clock (external TBCLK or ACLK) compared to MCLK. The compare mode is selected for the capture/compare channel and the CCRx register is incremented by 1 with the occurring compare interrupt (if TBR = CCRx).  
Due to the fast MCLK, the CCRx register increment ( $CCRx = CCRx + 1$ ) happens before the Timer\_B counter has incremented again. Therefore, the next compare interrupt should happen at once with the next Timer\_B counter increment (if  $TBR = CCRx + 1$ ).

This interrupt is lost.

**Workaround** Switch capture/compare mode to capture mode before the CCRx register increment. Switch back to compare mode afterward.

**TB16** *TIMER\_B Module*

**Category** Functional

**Function** First increment of TBR erroneous when IDx > 00

**Description** The first increment of TBR after any timer clear event (POR/TBCLR) happens immediately following the first positive edge of the selected clock source (INCLK, SMCLK, ACLK, or TBCLK). This is independent of the clock input divider settings (ID0, ID1). All following TBR increments are performed correctly with the selected IDx settings.

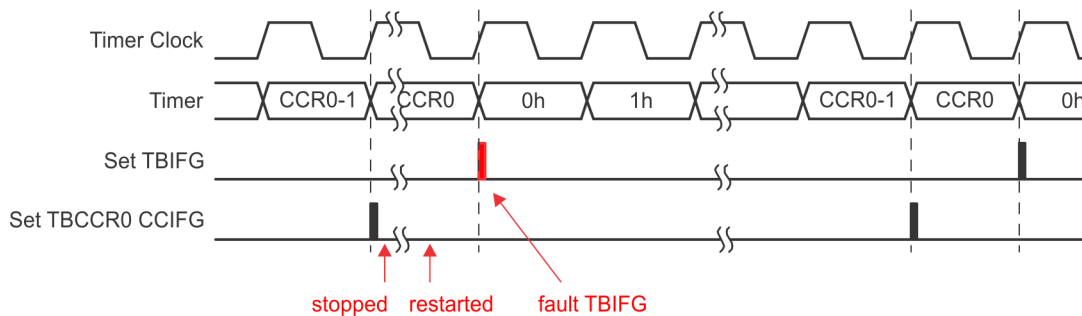
**Workaround** None

**TB24** *TIMER\_B Module*

**Category** Functional

**Function** TBIFG Flag is erroneously set after Timer B restarts in Up Mode

**Description** In Up Mode, the TBIFG flag should only be set when the timer resets from TBCCR0 to zero. However, if the Timer B is stopped at TBR = TBCCR0, then cleared (TBR=0) by setting the TBCLR bit, and finally restarted in Up Mode, the next rising edge of the TBCLK will erroneously set the TBIFG flag.



**Workaround** None.

**USCI20** *USCI Module*

**Category** Functional

**Function** I2C Mode Multi-master transmitter issue

**Description** When configured for I2C master-transmitter mode, and used in a multi-master environment, the USCI module can cause unpredictable bus behavior if all of the following four conditions are true:

1 - Two masters are generating SCL

And

2 - The slave is stretching the SCL low phase of an ACK period while outputting NACK

on SDA

And

3 - The slave drives ACK on SDA after the USCI has already released SCL, and then the SCL bus line gets released

And

4 - The transmit buffer has not been loaded before the other master continues communication by driving SCL low

The USCI will remain in the SCL high phase until the transmit buffer is written. After the transmit buffer has been written, the USCI will interfere with the current bus activity and may cause unpredictable bus behavior.

**Workaround**

1 - Ensure that slave doesn't stretch the SCL low phase of an ACK period

Or

2 - Ensure that the transmit buffer is loaded in time

Or

3 - Do not use the multi-master transmitter mode

**USCI21**
***USCI Module***


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**Category**

Functional

**Function**

UART IrDA receive filter

**Description**

The IrDA receive filter can be used to filter pulses with length UCAIRRXFL configured in UCAXIRRCTL register. If UCIRRXFE is set the IrDA receive decoder may filter out pulses longer than the configured filter length depending on frequency of BRCLK. This is resulting in framing errors or corrupted data on the receiver side.

**Workaround**

Depending on the used baud rate and the configured filter length a maximum frequency for BRCLK needs to be set to avoid this issue:

For baud rates equal and higher than 115.000 the maximum allowed BRCLK frequency is equal to the max specified system frequency.

$$\text{Max BRCLK} = \frac{\text{Filter Length} + 64}{2} \times \frac{\text{Baud Rate} \times 16}{3 \times 10^6}$$

Baud Rate	Filter Length UCIRRXFL (dec)	Max BRCLK (MHz)
9600	64	3.28
	32	2.46
	16	2.05
	8	1.84
	4	1.74
	2	1.69
	1	1.66
	0	1.64
19200	64	6.55
	32	4.92
	16	4.1
	8	3.69
	4	3.48
	2	3.38
	1	3.33
	0	3.28
38400	64	13.11
	32	9.83
	16	8.19
	8	7.37
	4	6.96
	2	6.76
	1	6.66
	0	6.55
56000	64	19.11
	32	14.34
	16	11.95
	8	10.75
	4	10.15
	2	9.86
	1	9.71
	0	9.56

**USCI22**
***USCI Module***
**Category**

Functional

**Function**

I2C Master Receiver with 10-bit slave addressing

**Description**

Unexpected behavior of the USCI\_B can occur when configured in I2C master receive mode with 10-bit slave addressing under the following conditions:

- 1) The USCI sends first byte of slave address, the slave sends an ACK and when second address byte is sent, the slave sends a NACK.
- 2) Master sends a repeat start condition (If UCTXSTT=1).
- 3) The first address byte following the repeated start is acknowledged.

However, the second address byte is not sent, instead the Master incorrectly starts to receive data and sets UCBxRXIFG=1.

**Workaround** Do not use repeated start condition instead set the stop condition UCTXSTP=1 in the NACK ISR prior to the following start condition (USTXSTT=1).

### **USCI23** *USCI Module*

---

**Category** Functional

**Function** UART transmit mode with automatic baud rate detection

**Description** Erroneous behavior of the USCI\_A can occur when configured in UART transmit mode with automatic baud rate detection. During transmission if a "Transmit break" is initiated (UCTXBRK=1), the USCI\_A will not deliver a stop bit of logic high, instead, it will send a logic low during the subsequent synch period.

**Workaround** 1) Follow User's Guide instructions for transmitting a break/synch field following UCSWRST=1.  
Or,  
2) Set UCTXBRK=1 before an active transmission, i.e. check for bit UCBUSY=0 and then set UCTXBRK=1.

### **USCI24** *USCI Module*

---

**Category** Functional

**Function** Incorrect baud rate information during UART automatic baud rate detection mode

**Description** Erroneous behavior of the USCI\_A can occur when configured in UART mode with automatic baud rate detection. After automatic baud rate measurement is complete, the UART updates UCAxBR0 and UCAxBR1. Under Oversampling mode (UCOS16=1), for baud rates that should result in UCAxBRx=0x0002, the UART incorrectly reports it as UCAxBRx=0x5555.

**Workaround** When break/synch is detected following the automatic baud rate detection, the flag UCBRK flag is set to 1. Check if UCAxBRx=0x5555 and correct it to 0x0002.

### **USCI25** *USCI Module*

---

**Category** Functional

**Function** TXIFG is not reset when NACK is received in I2C mode

**Description** When the USCI\_B module is configured as an I2C master transmitter the TXIFG is not reset after a NACK is received if the master is configured to send a restart (UCTXSTT=1 & UCTXSTP=0).

**Workaround** Reset TXIFG in software within the NACKIFG interrupt service routine

### **USCI26** *USCI Module*

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**Category** Functional



<b>Function</b>	Tbuf parameter violation in I2C multi-master mode
<b>Description</b>	<p>In multi-master I2C systems the timing parameter Tbuf (bus free time between a stop condition and the following start) is not guaranteed to match the I2C specification of 4.7us in standard mode and 1.3us in fast mode. If the UCTXSTT bit is set during a running I2C transaction, the USCI module waits and issues the start condition on bus release causing the violation to occur.</p> <p>Note: It is recommended to check if UCBBUSY bit is cleared before setting UCTXSTT=1.</p>
<b>Workaround</b>	None
<hr/>	
<b>USCI27</b>	<b><i>USCI Module</i></b>
<hr/>	
<b>Category</b>	Functional
<b>Function</b>	Timing of USCI I2C interrupts may cause device reset due to automatic clear of an IFG.
<b>Description</b>	<p>When certain USCI I2C interrupt flags (IFG) are set and an automatic flag-clearing event on the I2C bus occurs, the program counter may become corrupted. This will only happen when the IFG is cleared within a critical time window (~6 CPU clock cycles) after a USCI interrupt request occurs and before the interrupt servicing is initiated. The affected interrupts are UCBxTXIFG, UCSTPIFG, UCSTTIFG and UCNACKIFG.</p> <p>The automatic flag-clearing scenarios are described in the following situations:</p> <p>(1) A pending UCBxTXIFG interrupt request is cleared on the falling SCL clock edge following a NACK.</p> <p>(2) A pending UCSTPIFG, UCSTTIFG, or UCNACKIFG interrupt request is cleared by a following Start condition.</p>
<b>Workaround</b>	<p>(1) Polling the affected flags instead of enabling the interrupts.</p> <p>or</p> <p>(2) Ensuring the above mentioned flag-clearing events occur after a time delay of 6 CPU clock cycles has elapsed since the interrupt request occurred and was accepted.</p>
<hr/>	
<b>USCI30</b>	<b><i>USCI Module</i></b>
<hr/>	
<b>Category</b>	Functional
<b>Function</b>	I2C mode master receiver / slave receiver
<b>Description</b>	<p>When the USCI I2C module is configured as a receiver (master or slave), it performs a double-buffered receive operation. In a transaction of two bytes, once the first byte is moved from the receive shift register to the receive buffer the byte is acknowledged and the state machine allows the reception of the next byte.</p> <p>If the receive buffer has not been cleared of its contents by reading the UCBxRXBUF register while the 7th bit of the following data byte is being received, an error condition may occur on the I2C bus. Depending on the USCI configuration the following may occur:</p> <p>1) If the USCI is configured as an I2C master receiver, an unintentional repeated start condition can be triggered or the master switches into an idle state (I2C communication aborted). The reception of the current data byte is not successful in this case.</p> <p>2) If the USCI is configured as I2C slave receiver, the slave can switch to an idle state stalling I2C communication. The reception of the current data byte is not successful in</p>

this case. The USCI I2C state machine will notify the master of the aborted reception with a NACK.

Note that the error condition described above occurs only within a limited window of the 7th bit of the current byte being received. If the receive buffer is read outside of this window (before or after), then the error condition will not occur.

**Workaround**

a) The error condition can be avoided altogether by servicing the UCBxRXIFG in a timely manner. This can be done by (a) servicing the interrupt and ensuring UCBxRXBUF is read promptly or (b) Using the DMA to automatically read bytes from receive buffer upon UCBxRXIFG being set.

OR

b) In case the receive buffer cannot be read out in time, test the I2C clock line before the UCBxRXBUF is read out to ensure that the critical window has elapsed. This is done by checking if the clock line low status indicator bit UCSCLOW is set for atleast three USCI bit clock cycles i.e.  $3 \times t(\text{BitClock})$ .

Note that the last byte of the transaction must be read directly from UCBxRXBUF. For all other bytes follow the workaround:

Code flow for workaround

- (1) Enter RX ISR for reading receiving bytes
- (2) Check if UCSCLOW.UCBxSTAT == 1
- (3) If no, repeat step 2 until set
- (4) If yes, repeat step 2 for a time period  $> 3 \times t(\text{BitClock})$  where  $t(\text{BitClock}) = 1/f(\text{BitClock})$
- (5) If window of  $3 \times t(\text{BitClock})$  cycles has elapsed, it is safe to read UCBxRXBUF

**USCI34**
***USCI Module***


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**Category**

Functional

**Function**

I2C multi-master transmit may lose first few bytes.

**Description**

In an I2C multi-master system (UCMM =1), under the following conditions:

(1)the master is configured as a transmitter (UCTR =1)

AND

(2)the start bit is set (UCTXSTT =1);

if the I2C bus is unavailable, then the USCI module enters an idle state where it waits and checks for bus release. While in the idle state it is possible that the USCI master updates its TXIFG based on clock line activity due to other master/slave communication on the bus. The data byte(s) loaded in TXBUF while in idle state are lost and transmit pointers initialized by the user in the transmit ISR are updated incorrectly.

**Workaround**

Verify that the START condition has been sent (UCTXSTT =0) before loading TXBUF with data.

Example:

```
#pragma vector = USCIAB0TX_VECTOR
__interrupt void USCIAB0TX_ISR(void)
{
```

```

// Workaround for USCI34
if(UCB0CTL1&UCTXSTT)
{
// TXData = pointer to the transmit buffer start
// PTxData = pointer to transmit in the ISR
PTxData = TXData; // restore the transmit buffer pointer if the Start bit is set
}
//
if(IFG2&UCB0TXIFG)
{
if (PTxData<=PTxDataEnd) // Check TX byte counter
{
UCB0TXBUF = *PTxData++; // Load TX buffer
}
else
{
UCB0CTL1 |= UCTXSTP; // I2C stop condition
IFG2 &= ~UCB0TXIFG; // Clear USCI_B0 TX int flag
__bic_SR_register_on_exit(CPUOFF); // Exit LPM0
}
}
}

```

## USCI35

### *USCI Module*

#### Category

Functional

#### Function

Violation of setup and hold times for (repeated) start in I2C master mode

#### Description

In I2C master mode, the setup and hold times for a (repeated) START,  $t_{SU,STA}$  and  $t_{HD,STA}$  respectively, can be violated if SCL clock frequency is greater than 50kHz in standard mode (100kbps). As a result, a slave can receive incorrect data or the I2C bus can be stalled due to clock stretching by the slave.

#### Workaround

If using repeated start, ensure SCL clock frequencies is < 50kHz in I2C standard mode (100 kbps).

## USCI40

### *USCI Module*

#### Category

Functional

#### Function

SPI Slave Transmit with clock phase select = 1

#### Description

In SPI slave mode with clock phase select set to 1 (UCAxCTLW0.UCCKPH=1), after the first TX byte, all following bytes are shifted by one bit with shift direction dependent on UCMSB. This is due to the internal shift register getting pre-loaded asynchronously when writing to the USCIA TXBUF register. TX data in the internal buffer is shifted by one bit

after the RX data is received.

**Workaround**

Reinitialize TXBUF before using SPI and after each transmission.

If transmit data needs to be repeated with the next transmission, then write back previously read value:

```
UCAxTXBUF = UCAxTXBUF;
```

**XOSC5**
***XOSC Module***


---

**Category**

Functional

**Function**

LF crystal failures may not be properly detected by the oscillator fault circuitry

**Description**

The oscillator fault error detection of the LFXT1 oscillator in low frequency mode (XTS = 0) may not work reliably causing a failing crystal to go undetected by the CPU, i.e. OFIFG will not be set.

**Workaround**

None

**XOSC8**
***XOSC Module***


---

**Category**

Functional

**Function**

ACLK failure when crystal ESR is below 40 kOhm.

**Description**

When ACLK is sourced by a low frequency crystal with an ESR below 40 kOhm, the duty cycle of ACLK may fall below the specification; the OFIFG may become set or in some instances, ACLK may stop completely.

**Workaround**

Please refer to "XOSC8 Guidance" found at [SLAA423](#) for information regarding working with this erratum.

## 7 Document Revision History

Changes from family erratasheet to device specific erratasheet.

1. Errata CPU19 was removed
2. Description for TAB22 was updated
3. Function for BCL13 was updated
4. ADC19 is impacting silicon Revision A

Changes from device specific erratasheet to document Revision A.

1. Errata BCL15 was added to the errata documentation.

Changes from document Revision A to Revision B.

1. BCL12 Workaround was updated.

Changes from document Revision B to Revision C.

1. Errata TA21 was added to the errata documentation.

Changes from document Revision C to Revision D.

1. Errata TB24 was added to the errata documentation.

Changes from document Revision D to Revision E.

1. Errata USCI35 was added to the errata documentation.

Changes from document Revision E to Revision F.

1. Errata JTAG23 was added to the errata documentation.

Changes from document Revision F to Revision G.

1. Package Markings section was updated.
2. Errata SVS2 was removed from the errata documentation.
3. Errata DAC4 was added to the errata documentation.

Changes from document Revision G to Revision H.

1. DAC4 Workaround was updated.
2. Errata USCI40 was added to the errata documentation.
3. DAC4 Function was updated.
4. DAC4 Description was updated.

Changes from document Revision H to Revision I.

1. TA21 Description was updated.

Changes from document Revision I to Revision J.

1. Errata JTAG27 was added to the errata documentation.

Changes from document Revision J to Revision K.

1. DMA13 was added to the errata documentation.
2. Description for CPU8 was updated.
3. Workaround for CPU8 was updated.
4. Workaround for CPU16 was updated.

Changes from document Revision K to Revision L.

1. Function for BCL15 was updated.
2. Description for BCL15 was updated.
3. Workaround for BCL15 was updated.

Changes from document Revision L to Revision M.

1. Erratasheet format update.
2. Added errata category field to "Detailed bug description" section

Changes from document Revision M to Revision N.

1. CPU19 was added to the errata documentation.

Changes from document Revision N to Revision O.

1. CPU47 was added to the errata documentation.

Changes from document Revision O to Revision P.

1. USCI34 was added to the errata documentation.

Changes from document Revision P to Revision Q.

1. Description for TB24 was updated.

Changes from document Revision Q to Revision R.

1. Silicon Revision D was removed from the errata documentation.
2. Silicon Revision B was removed from the errata documentation.
3. Silicon Revision A was removed from the errata documentation.
4. ADC18 was removed from the errata documentation.
5. USCI16 was removed from the errata documentation.
6. ADC19 was removed from the errata documentation.
7. TB19 was removed from the errata documentation.
8. JTAG27 was removed from the errata documentation.
9. FLASH23 was removed from the errata documentation.
10. FLASH22 was removed from the errata documentation.
11. COMP2 was removed from the errata documentation.
12. CPU47 was removed from the errata documentation.
13. XOSC6 was removed from the errata documentation.

Changes from document Revision R to Revision S.

1. ZCA113 was added to errata documentation

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